

08N50-SE2 Preliminary Power MOSFET

0.8A, 500V N-CHANNEL POWER MOSFET

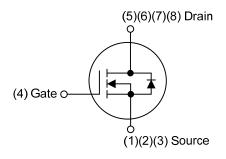
■ DESCRIPTION

The UTC **08N50-SE2** is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient AC to DC converters and bridge circuits.

■ FEATURES

- * $R_{DS(ON)} \le 12 \Omega$ @ $V_{GS}=10V$, $I_D=0.4A$
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

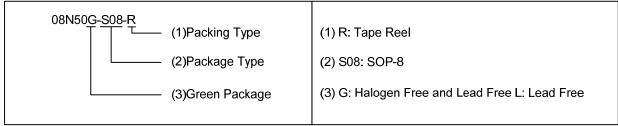
■ SYMBOL



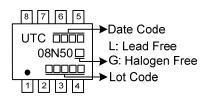
ORDERING INFORMATION

Ordering Number		Doolsono	Pin Assignment							Doolsing	
Lead Free	Halogen Free	Package	1	2	3	4	5	6	7	8	Packing
08N50L-S08-R	08N50G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



SOP-8

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■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{ extsf{DSS}}$	500	V
Gate-Source Voltage		V_{GSS}	ss ±30	
Drain Current	Continuous	I _D	0.8	Α
	Pulsed (Note 2)	I _{DM}	1.6	Α
Peak Diode Recovery dv/dt (Note 3)		dv/dt	5.1	V/ns
Power Dissipation		P _D	1.7	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. $I_{SD} \le 0.8A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	90	°C/W	
Junction to Case	θјς	73.5	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

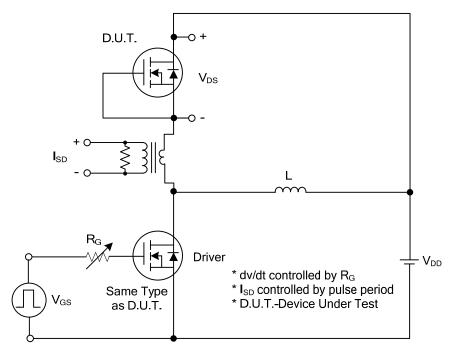
■ ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified)

						1			
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS			,						
Drain-Source Breakdown Voltage		BV _{DSS}	V_{GS} =0V, I_D =250 μ A	500			V		
Drain-Source Leakage Current		I_{DSS}	V _{DS} =500V, V _{GS} =0V			10	μΑ		
Gate-Source Leakage Current	Forward		V_{GS} =30V, V_{DS} =0V			100	nA		
	Reverse	I _{GSS}	V_{GS} =-30V, V_{DS} =0V			-100	nA		
ON CHARACTERISTICS									
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V		
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =0.4A			12	Ω		
DYNAMIC CHARACTERISTICS									
Input Capacitance		C _{ISS}			70		pF		
Output Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1MHz		14		pF		
Reverse Transfer Capacitance		C_{RSS}			2.4		pF		
SWITCHING CHARACTERISTICS									
Total Gate Charge (Note 1)		Q_{G}	V _{DS} =400V, V _{GS} =10V, I _D =0.8A		10		nC		
Gate to Source Charge		Q_GS	(Note 1, 2)		4		nC		
Gate to Drain Charge		Q_GD	(Note 1, 2)		1.2		nC		
Turn-ON Delay Time (Note 1)		t _{D (ON)}			4		ns		
Rise Time		t_{R}	V_{DD} =100V, V_{GS} =10V, I_{D} =0.8A,		17		ns		
Turn-OFF Delay Time		t _{D (OFF)}	R _G =25Ω (Note 1, 2)		13		ns		
Fall-Time		t_{F}			32		ns		
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS									
Maximum Body-Diode Continuous Current		Is				0.8	Α		
Maximum Body-Diode Pulsed Current (Note 1)		I _{SM}				1.6	Α		
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =0.8A, V _{GS} =0V			1.4	V		
Body Diode Reverse Recovery Time		t _{rr}	I _S =0.8A, V _{GS} =0V		138		ns		
Body Diode Reverse Recovery Charge		Q _{rr}	dl _F /dt=100A/µs		220		nC		

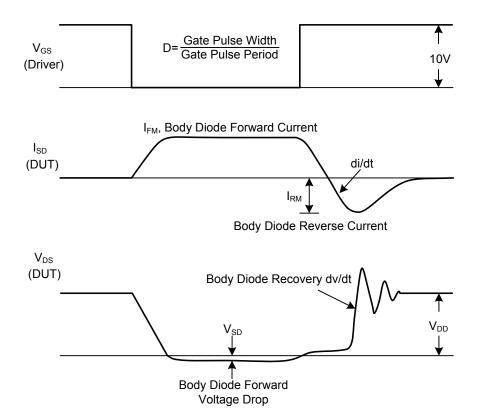
Notes: 1. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%

2. Essentially independent of operating temperature.

TEST CIRCUITS AND WAVEFORMS

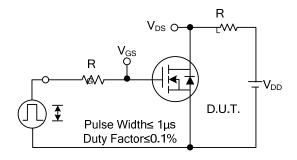


Peak Diode Recovery dv/dt Test Circuit

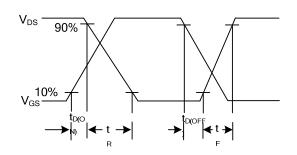


Peak Diode Recovery dv/dt Waveforms

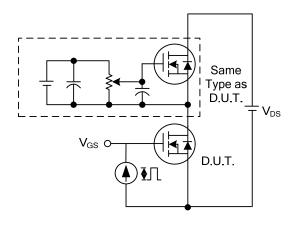
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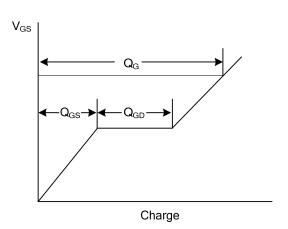
Switching Test Circuit



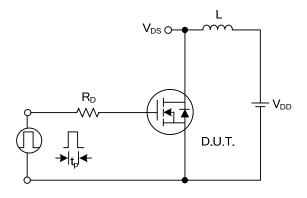
Switching Waveforms



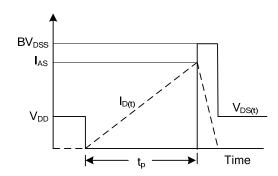
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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